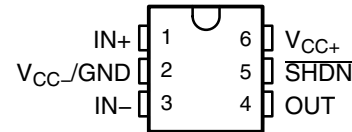
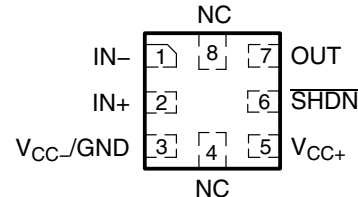


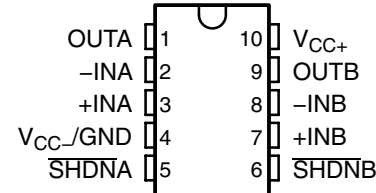
LMV981 SINGLE, LMV982 DUAL 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT AND SHUTDOWN

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- 1.8-V, 2.7-V, and 5-V Specifications
- Rail-to-Rail Output Swing
 - 600- Ω Load . . . 80 mV From Rail
 - 2-k Ω Load . . . 30 mV From Rail
- V_{ICR} . . . 200 mV Beyond Rails
- Gain Bandwidth . . . 1.4 MHz
- Supply Current . . . 100 μ A/Amplifier
- Max V_{IO} . . . 4 mV
- Turn-On Time From Shutdown . . . 8.4 μ s
- Space-Saving Packages
 - LMV981: SOT-23-6, SC-70, and QFN
 - LMV982: MSOP and VSSOP
- Applications
 - Industrial (Utility/Energy Metering)
 - Automotive
 - Communications (Optical Telecom, Data/Voice Cable Modems)
 - Consumer Electronics (PDAs, PCs, CDR/W, Portable Audio)
 - Supply-Current Monitoring
 - Battery Monitoring

LMV981 . . . DBV (SOT23-6) OR DCK (SC-70) PACKAGE
(TOP VIEW)LMV981 . . . RUG (QFN) PACKAGE
(TOP VIEW)

NC – No internal connection

LMV982 . . . DGS (VSSOP/MSOP) PACKAGE
(TOP VIEW)

description/ordering information

The LMV981 and LMV982 devices are low-voltage, low-power operational amplifiers that are well suited for today's low-voltage and/or portable applications. Specified for operation of 1.8 V to 5 V, they can be used in portable applications that are powered from a single-cell Li-ion or two-cell batteries. They have rail-to-rail input and output capability for maximum signal swings in low-voltage applications. The LMV98x input common-mode voltage extends 200 mV beyond the rails for increased flexibility. The output can swing rail-to-rail unloaded and typically can reach 80 mV from the rails, while driving a 600- Ω load (at 1.8-V operation).

ORDERING INFORMATION†

T _A	PACKAGE [‡]			ORDERABLE PART NUMBER	TOP-SIDE MARKING [§]
–40°C to 125°C	Single	QFN (RUG)	Reel of 3000	LMV981IRUGR	R7
		SOT-23 (DBV)	Reel of 3000	LMV981IDBVR	RBA_
			Reel of 250	LMV981IDBVT	PREVIEW
		SC-70 (DCK)	Reel of 3000	LMV981IDCKR	R7_
			Reel of 250	LMV981IDCKT	PREVIEW
	Dual	MSOP/VSSOP (DGS)	Reel of 2500	LMV982IDGSR	RCB
			Reel of 250	LMV982IDGST	

† For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

‡ Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

§ DBV/DCK: The actual top-side marking has one additional character that designates the wafer fab/assembly site.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
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LMV981 SINGLE, LMV982 DUAL

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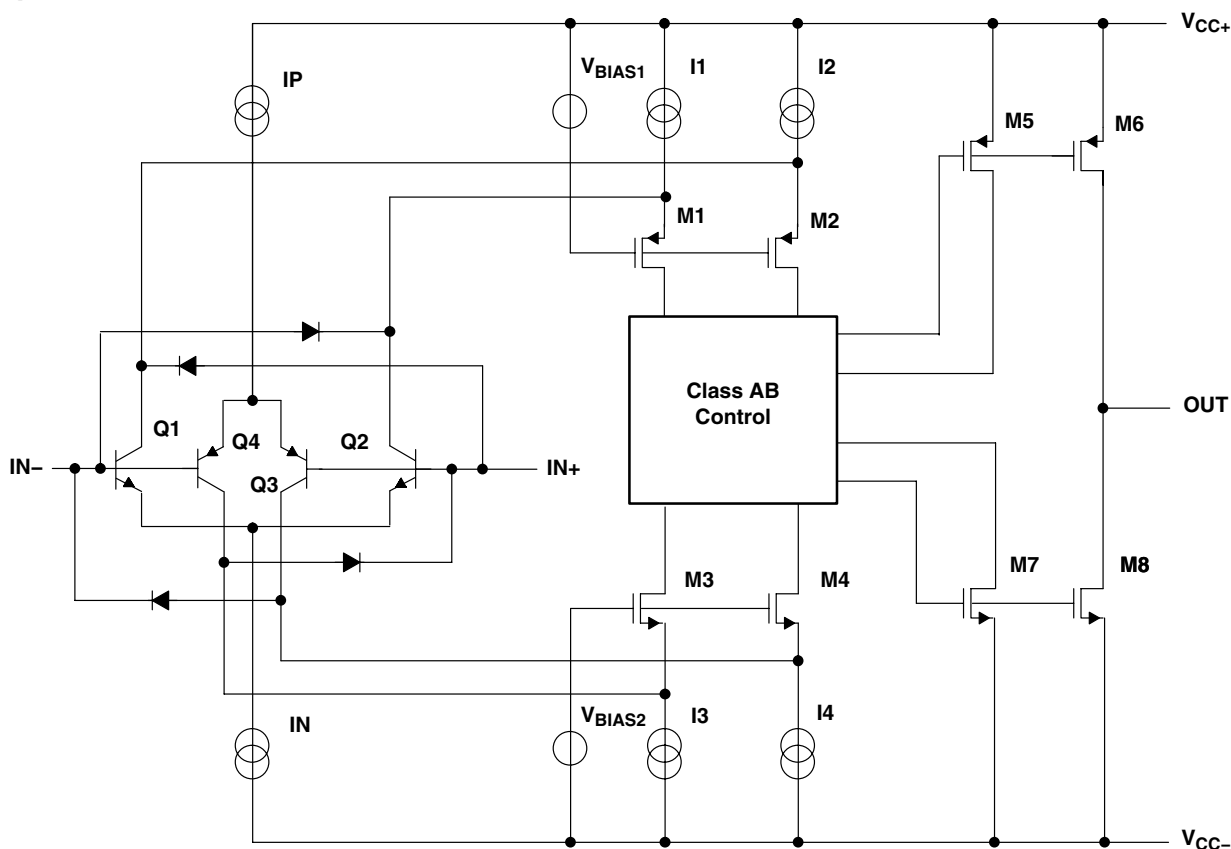
description/ordering information (continued)

The LMV981 and LMV982 devices offer shutdown capability for additional power savings. Pulling the SHDN pin low puts the amplifiers in shutdown, where only 0.156 μA typically is consumed from a 1.8-V supply. In normal operation with the same 1.8-V supply, the devices typically consume a quiescent current of 103 μA per channel, and yet they are able to achieve excellent electrical specifications, such as 101-dB open-loop DC gain and 1.4-MHz-gain bandwidth. Furthermore, the amplifiers offer good output drive characteristics, with the ability to drive a 600- Ω load and 1000-pF capacitance, with minimal ringing.

The LMV981 and LMV982 devices are offered in the latest packaging technology to meet the most demanding space-constraint applications. The LMV981 is offered in standard SOT-23 and SC-70 packages. The LMV982 is available in the 10-pin MSOP package.

The LMV98x devices are characterized for operation from -40°C to 125°C , making them universally suited for commercial, industrial, and automotive applications.

simplified schematic



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absolute maximum ratings over free-air temperature range (unless otherwise noted)[†]

Supply voltage, $V_{CC+} - V_{CC-}$ (see Note 1)	5.5 V
Differential input voltage, V_{ID} (see Note 2)	Supply voltage
Input voltage range, V_I (either input)	$V_{CC-} - 0.2 \text{ V}$ to $V_{CC+} + 0.2 \text{ V}$
Duration of output short circuit (one amplifier) to $V_{CC\pm}$ (see Notes 3 and 4)	Unlimited
Package thermal impedance, θ_{JA} (see Notes 4 and 5):	
DBV package	165°C/W
DCK package	259°C/W
DGS package	165°C/W
RUG package	253°C/W
Operating virtual junction temperature, T_J	150°C
Storage temperature range, T_{stg}	–65 to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.
 2. Differential voltages are at $IN+$ with respect to $IN-$.
 3. Applies to both single-supply and split-supply operation. Continuous short-circuit operation at elevated ambient temperature can result in exceeding the maximum-allowed junction temperature of 150°C. Output currents in excess of 45 mA over long term may adversely affect reliability.
 4. Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
 5. The package thermal impedance is calculated in accordance with JEDEC 51-7.

recommended operating conditions

	MIN	MAX	UNIT
V_{CC} Supply voltage ($V_{CC+} - V_{CC-}$)	1.8	5	V
T_A Operating free-air temperature	–40	125	°C

ESD protection

TEST CONDITIONS	TYP	UNIT
Human-Body Model	2000	V
Machine Model	200	V

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electrical characteristics at $T_A = 25^\circ\text{C}$, $V_{CC+} = 1.8\text{ V}$, $V_{CC-} = 0\text{ V}$, $V_{IC} = V_{CC+}/2$, $V_O = V_{CC+}/2$, $R_L > 1\text{ M}\Omega$, and SHDN tied to V_{CC+} (unless otherwise noted)

PARAMETER			TEST CONDITIONS		T _A	MIN	TYP	MAX	UNIT
V _{IO}	Input offset voltage	LMV981 (single)		25°C		1		4	mV
				Full range			6		
		LMV982 (dual)		25°C		1		5.5	
				Full range			7.5		
α _{V_{IO}}	Average temperature coefficient of input offset voltage			25°C		5.5			μV/°C
I _{IB}	Input bias current	V _{IC} = V _{CC+} − 0.8 V		25°C		15		35	nA
				25°C			65		
				Full range			75		
I _{IO}	Input offset current			25°C		13		25	nA
				Full range			40		
I _{CC}	Supply current (per channel)			25°C		103		185	μA
				Full range			205		
		In shutdown	LMV981	25°C		0.156		1	
				Full range			2		
			LM982	25°C		0.178		3.5	
				Full range			5		
CMRR	Common-mode rejection ratio	0 ≤ V _{IC} ≤ 0.6 V, 1.4 V ≤ V _{IC} ≤ 1.8 V		25°C		60	78	dB	
				−40°C to 85°C		55			
		0.2 V ≤ V _{IC} ≤ 0.6 V, 1.4 V ≤ V _{IC} ≤ 1.6 V		−40°C to 125°C		55			
				25°C		50	72		
k _{SVR}	Supply-voltage rejection ratio	1.8 V ≤ V _{CC+} ≤ 5 V, V _{IC} = 0.5 V		25°C		75	100	dB	
				Full range		70			
V _{ICR}	Common-mode input voltage range	CMRR ≥ 50 dB		25°C	V _{CC−} − 0.2	−0.2 to 2.1	V _{CC+} + 0.2	V	
				−40°C to 85°C	V _{CC−}		V _{CC+}		
				−40°C to 125°C	V _{CC−} + 0.2		V _{CC+} − 0.2		
A _V	Large-signal voltage gain	LMV981	R _L = 600 Ω to 0.9 V, V _O = 0.2 V to 1.6 V, V _{IC} = 0.5 V	25°C	77	101	dB		
				Full range	73				
			R _L = 2 kΩ to 0.9 V, V _O = 0.2 V to 1.6 V, V _{IC} = 0.5 V	25°C	80	105			
				Full range	75				
		LMV982	R _L = 600 Ω to 0.9 V, V _O = 0.2 V to 1.6 V, V _{IC} = 0.5 V	25°C	75	90			
				Full range	72				
			R _L = 2 kΩ to 0.9 V, V _O = 0.2 V to 1.6 V, V _{IC} = 0.5 V	25°C	78	100			
				Full range	75				

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electrical characteristics at $T_A = 25^\circ\text{C}$, $V_{CC+} = 1.8\text{ V}$, $V_{CC-} = 0\text{ V}$, $V_{IC} = V_{CC+}/2$, $V_O = V_{CC+}/2$, $R_L > 1\text{ M}\Omega$, and SHDN tied to V_{CC+} (unless otherwise noted) (continued)

PARAMETER		TEST CONDITIONS		T_A	MIN	TYP	MAX	UNIT
V_O	Output swing	$R_L = 600\ \Omega$ to 0.9 V , $V_{ID} = \pm 100\text{ mV}$	High level	25°C	1.65	1.72		V
				Full range	1.63			
			Low level	25°C		0.077	0.105	
				Full range			0.12	
		$R_L = 2\text{ k}\Omega$ to 0.9 V , $V_{ID} = \pm 100\text{ mV}$	High level	25°C	1.75	1.77		
				Full range	1.74			
			Low level	25°C		0.024	0.035	
				Full range			0.04	
I_{OS}	Output short-circuit current	$V_O = 0\text{ V}$, $V_{ID} = 100\text{ mV}$	Sourcing	25°C	4	8		mA
				Full range	3.3			
		$V_O = 1.8\text{ V}$, $V_{ID} = -100\text{ mV}$	Sinking	25°C	7	9		
				Full range	5			
T_{on}	Turn-on time from shutdown			25°C		19		μs
V_{SHDN}	Turn-on voltage to enable part			25°C		1.0		V
	Turn-off voltage					0.55		
GBW	Gain bandwidth product			25°C		1.4		MHz
SR	Slew rate	See Note 6		25°C		0.35		$\text{V}/\mu\text{s}$
Φ_m	Phase margin			25°C		67		deg
	Gain margin			25°C		7		dB
V_n	Equivalent input noise voltage	$f = 1\text{ kHz}$, $V_{IC} = 0.5\text{ V}$		25°C		60		$\text{nV}/\sqrt{\text{Hz}}$
I_n	Equivalent input noise current	$f = 1\text{ kHz}$		25°C		0.06		$\text{pA}/\sqrt{\text{Hz}}$
THD	Total harmonic distortion	$f = 1\text{ kHz}$, $A_V = 1$, $R_L = 600\ \Omega$, $V_{ID} = 1\text{ V}_{PP}$		25°C		0.023		%
	Amp-to-amp isolation	See Note 7		25°C		123		dB

- NOTES: 6. Number specified is the slower of the positive and negative slew rates.
7. Input referred, $V_{CC+} = 5\text{ V}$ and $R_L = 100\text{ k}\Omega$ connected to 2.5 V . Each amp is excited in turn with a 1-kHz signal to produce $V_O = 3\text{ V}_{PP}$.

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electrical characteristics at $T_A = 25^\circ\text{C}$, $V_{CC+} = 2.7\text{ V}$, $V_{CC-} = 0\text{ V}$, $V_{IC} = V_{CC+}/2$, $V_O = V_{CC+}/2$, $R_L > 1\text{ M}\Omega$, and SHDN tied to V_{CC+} (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T _A	MIN	TYP	MAX	UNIT
V _{IO}	Input offset voltage	LMV981 (single)		25°C		1	4	mV
				Full range			6	
		LMV982 (dual)		25°C		1	5.5	
				Full range			7.5	
α _{V_{IO}}	Average temperature coefficient of input offset voltage			25°C		5.5		μV/°C
I _{IB}	Input bias current	V _{IC} = V _{CC+} – 0.8 V		25°C		15	35	nA
				25°C			65	
				Full range			75	
I _{IO}	Input offset current			25°C		8	25	nA
				Full range			40	
I _{CC}	Supply current (per channel)			25°C		105	190	μA
				Full range			210	
		In shutdown	LMV981	25°C		0.61	1	
				Full range			2	
			LM982	25°C		0.101	3.5	
				Full range			5	
CMRR	Common-mode rejection ratio	0 ≤ V _{IC} ≤ 1.5 V, 2.3 V ≤ V _{IC} ≤ 2.7 V		25°C	60	81	dB	
				–40°C to 85°C	55			
		0.2 ≤ V _{IC} ≤ 1.5 V, 2.3 V ≤ V _{IC} ≤ 2.5 V		–40°C to 125°C	55			
				25°C	50	74		
k _{SVR}	Supply-voltage rejection ratio	1.8 V ≤ V _{CC+} ≤ 5 V, V _{IC} = 0.5 V		25°C	75	100	dB	
				Full range	70			
V _{ICR}	Common-mode input voltage range	CMRR ≥ 50 dB		25°C	V _{CC–} – 0.2	–0.2 to 3.0	V _{CC+} + 0.2	V
				–40°C to 85°C	V _{CC–}		V _{CC+}	
				–40°C to 125°C	V _{CC–} + 0.2		V _{CC+} – 0.2	
A _V	Large-signal voltage gain	LMV981	R _L = 600 Ω to 1.35 V, V _O = 0.2 V to 2.5 V	25°C	87	104	dB	
				Full range	86			
			R _L = 2 kΩ to 1.35 V, V _O = 0.2 V to 2.5 V	25°C	92	110		
				Full range	91			
		LMV982	R _L = 600 Ω to 1.35 V, V _O = 0.2 V to 2.5 V	25°C	78	90		
				Full range	75			
			R _L = 2 kΩ to 1.35 V, V _O = 0.2 V to 2.5 V	25°C	81	100		
				Full range	78			

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characteristics at $T_A = 25^\circ\text{C}$, $V_{CC+} = 2.7\text{ V}$, $V_{CC-} = 0\text{ V}$, $V_{IC} = V_{CC+}/2$, $V_O = V_{CC+}/2$, $R_L > 1\text{ M}\Omega$, and SHDN tied to V_{CC+} (unless otherwise noted) (continued)

PARAMETER		TEST CONDITIONS		T_A	MIN	TYP	MAX	UNIT
V_O	Output swing	$R_L = 600\ \Omega$ to 1.35 V , $V_{ID} = \pm 100\text{ mV}$	High level	25°C	2.55	2.62		V
				Full range	2.53			
			Low level	25°C		0.083	0.11	
				Full range			0.13	
		$R_L = 2\text{ k}\Omega$ to 1.35 V , $V_{ID} = \pm 100\text{ mV}$	High level	25°C	2.65	2.675		
				Full range	2.64			
			Low level	25°C		0.025	0.04	
				Full range			0.045	
I_{OS}	Output short-circuit current	$V_O = 0\text{ V}$, $V_{ID} = 100\text{ mV}$	Sourcing	25°C	20	30		mA
				Full range	15			
		$V_O = 2.7\text{ V}$, $V_{ID} = -100\text{ mV}$	Sinking	25°C	18	25		
				Full range	12			
T_{on}	Turn-on time from shutdown			25°C		12.5		μs
V_{SHDN}	Turn-on voltage to enable part			25°C		1.9		V
	Turn-off voltage					0.8		
GBW	Gain bandwidth product			25°C		1.4		MHz
SR	Slew rate	See Note 6		25°C		0.4		$\text{V}/\mu\text{s}$
Φ_m	Phase margin			25°C		70		deg
	Gain margin			25°C		7.5		dB
V_n	Equivalent input noise voltage	$f = 1\text{ kHz}$, $V_{IC} = 0.5\text{ V}$		25°C		57		$\text{nV}/\sqrt{\text{Hz}}$
I_n	Equivalent input noise current	$f = 1\text{ kHz}$		25°C		0.082		$\text{pA}/\sqrt{\text{Hz}}$
THD	Total harmonic distortion	$f = 1\text{ kHz}$, $A_V = 1$, $R_L = 600\ \Omega$, $V_{ID} = 1\text{ V}_{PP}$		25°C		0.022		%
	Amp-to-amp isolation	See Note 7		25°C		123		dB

- NOTES: 6. Number specified is the slower of the positive and negative slew rates.
7. Input referred, $V_{CC+} = 5\text{ V}$ and $R_L = 100\text{ k}\Omega$ connected to 2.5 V . Each amp is excited in turn with a 1-kHz signal to produce $V_O = 3\text{ V}_{PP}$.

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electrical characteristics at $T_A = 25^\circ\text{C}$, $V_{CC+} = 5\text{ V}$, $V_{CC-} = 0\text{ V}$, $V_{IC} = V_{CC+}/2$, $V_O = V_{CC+}/2$, $R_L > 1\text{ M}\Omega$, and SHDN tied to V_{CC+} (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T _A	MIN	TYP	MAX	UNIT
V _{IO}	Input offset voltage	LMV981 (single)		25°C		1	4	mV
				Full range			6	
		LMV982 (dual)		25°C		1	5.5	
				Full range			7.5	
α _{V_{IO}}	Average temperature coefficient of input offset voltage			25°C		5.5		μV/°C
I _{IB}	Input bias current	V _{IC} = V _{CC+} − 0.8 V		25°C		15	35	nA
				25°C		65		
				Full range			75	
I _{IO}	Input offset current			25°C		9	25	nA
				Full range			40	
I _{CC}	Supply current (per channel)			25°C		116	210	μA
				Full range			230	
		In shutdown	LMV981	25°C		0.201	1	
				Full range			2	
			LM982	25°C		0.302	3.5	
				Full range			5	
CMRR	Common-mode rejection ratio	0 ≤ V _{IC} ≤ 3.8 V, 4.6 V ≤ V _{IC} ≤ 5 V		25°C	60	86	dB	
				−40°C to 85°C		55		
		0.3 ≤ V _{IC} ≤ 3.8 V, 4.6 V ≤ V _{IC} ≤ 4.7 V		−40°C to 125°C		55		
				25°C	50	78		
k _{SVR}	Supply-voltage rejection ratio	1.8 V ≤ V _{CC+} ≤ 5 V, V _{IC} = 0.5 V		25°C	75	100	dB	
				Full range		70		
V _{ICR}	Common-mode input voltage range	CMRR ≥ 50 dB		25°C	V _{CC−} − 0.2	−0.2 to 5.3	V _{CC+} + 0.2	V
				−40°C to 85°C		V _{CC−}	V _{CC+}	
				−40°C to 125°C		V _{CC−} + 0.3	V _{CC+} − 0.3	
A _V	Large-signal voltage gain	LMV981	R _L = 600 Ω to 2.5 V, V _O = 0.2 V to 4.8 V	25°C	88	102	dB	
				Full range		87		
			R _L = 2 kΩ to 2.5 V, V _O = 0.2 V to 4.8 V	25°C	94	113		
				Full range		93		
		LMV982	R _L = 600 Ω to 2.5 V, V _O = 0.2 V to 4.8 V	25°C	81	90		
				Full range		78		
			R _L = 2 kΩ to 2.5 V, V _O = 0.2 V to 4.8 V	25°C	85	100		
				Full range		82		

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electrical characteristics at $T_A = 25^\circ\text{C}$, $V_{CC+} = 5\text{ V}$, $V_{CC-} = 0\text{ V}$, $V_{IC} = V_{CC+}/2$, $V_O = V_{CC+}/2$, $R_L > 1\text{ M}\Omega$, and SHDN tied to V_{CC+} (unless otherwise noted) (continued)

PARAMETER		TEST CONDITIONS		T_A	MIN	TYP	MAX	UNIT
V_O	Output swing	$R_L = 600\ \Omega$ to 2.5 V , $V_{ID} = \pm 100\text{ mV}$	High level	25°C	4.855	4.89		V
				Full range	4.835			
			Low level	25°C		0.12	0.16	
				Full range			0.18	
		$R_L = 2\text{ k}\Omega$ to 2.5 V , $V_{ID} = \pm 100\text{ mV}$	High level	25°C	4.945	4.967		
				Full range	4.935			
			Low level	25°C		0.037	0.065	
				Full range			0.075	
I_{OS}	Output short-circuit current	LMV981: $V_O = 0\text{ V}$, $V_{ID} = 100\text{ mV}$	Sourcing	25°C	80	100		mA
				Full range	68			
		$V_O = 5\text{ V}$, $V_{ID} = -100\text{ mV}$	Sinking	25°C	58	65		
				Full range	45			
T_{on}	Turn-on time from shutdown			25°C		8.4		μs
V_{SHDN}	Turn-on voltage to enable part			25°C		4.2		V
	Turn-off voltage					0.8		
GBW	Gain bandwidth product			25°C		1.5		MHz
SR	Slew rate	See Note 6		25°C		0.42		$\text{V}/\mu\text{s}$
Φ_m	Phase margin			25°C		71		deg
	Gain margin			25°C		8		dB
V_n	Equivalent input noise voltage	$f = 1\text{ kHz}$, $V_{IC} = 1\text{ V}$		25°C		50		$\text{nV}/\sqrt{\text{Hz}}$
I_n	Equivalent input noise current	$f = 1\text{ kHz}$		25°C		0.07		$\text{pA}/\sqrt{\text{Hz}}$
THD	Total harmonic distortion	$f = 1\text{ kHz}$, $A_V = 1$, $R_L = 600\ \Omega$, $V_{ID} = 1\text{ V}_{PP}$		25°C		0.022		%
	Amp-to-amp isolation	See Note 7		25°C		123		dB

- NOTES: 6. Number specified is the slower of the positive and negative slew rates.
7. Input referred, $V_{CC+} = 5\text{ V}$ and $R_L = 100\text{ k}\Omega$ connected to 2.5 V . Each amp is excited in turn with a 1-kHz signal to produce $V_O = 3\text{ V}_{PP}$.

LMV981 SINGLE, LMV982 DUAL 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT AND SHUTDOWN

SLOS440H – AUGUST 2004 – REVISED JULY 2007

TYPICAL PERFORMANCE CHARACTERISTICS

Unless Otherwise Specified, $V_{CC+} = 5\text{ V}$, Single Supply, $T_A = 25^\circ\text{C}$

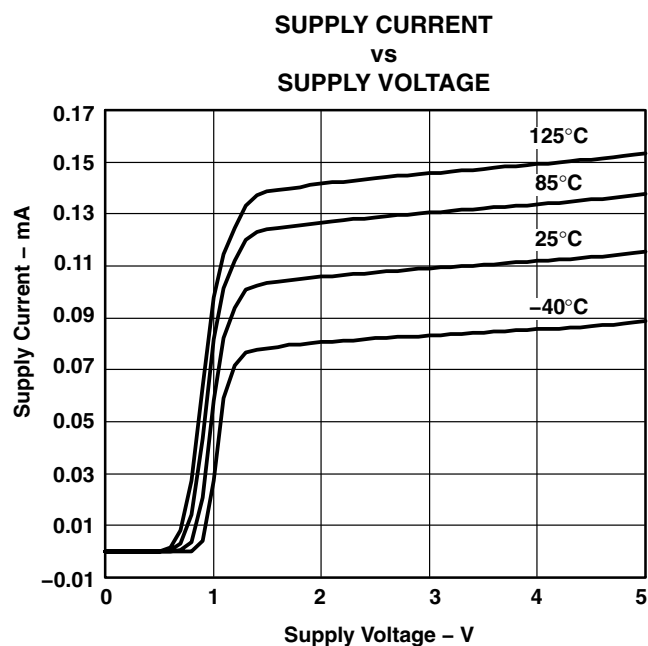


Figure 1

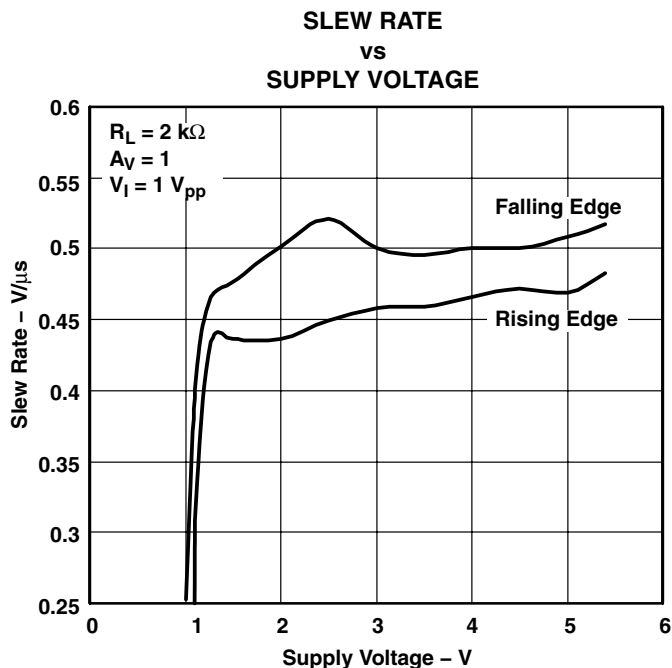


Figure 2

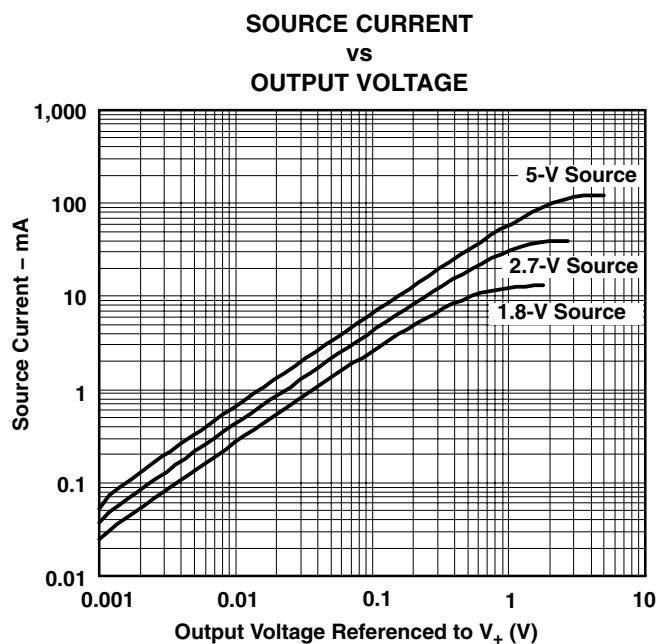


Figure 3

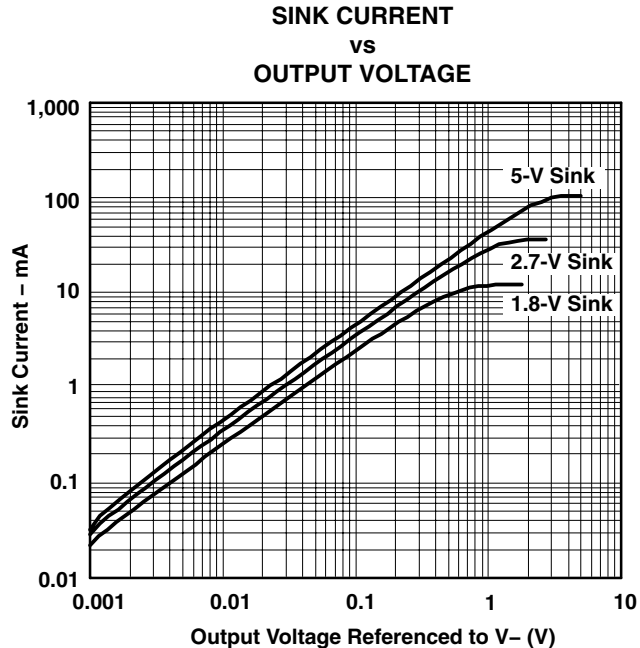


Figure 4

LMV981 SINGLE, LMV982 DUAL 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT AND SHUTDOWN

SLOS440H – AUGUST 2004 – REVISED JULY 2007

TYPICAL PERFORMANCE CHARACTERISTICS

Unless Otherwise Specified, $V_{CC+} = 5\text{ V}$, Single Supply, $T_A = 25^\circ\text{C}$

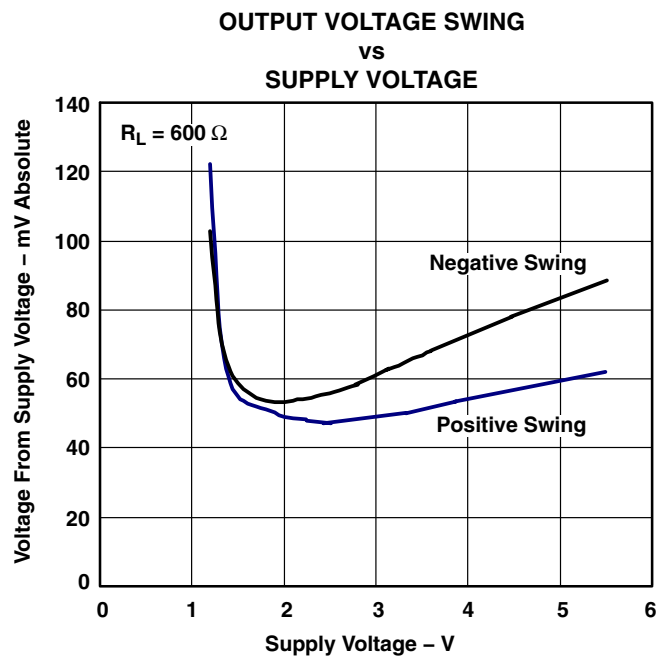


Figure 5

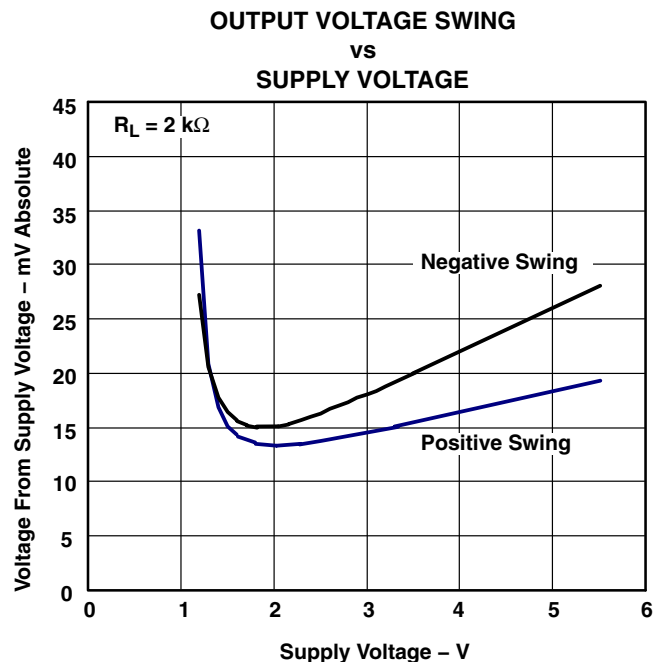


Figure 6

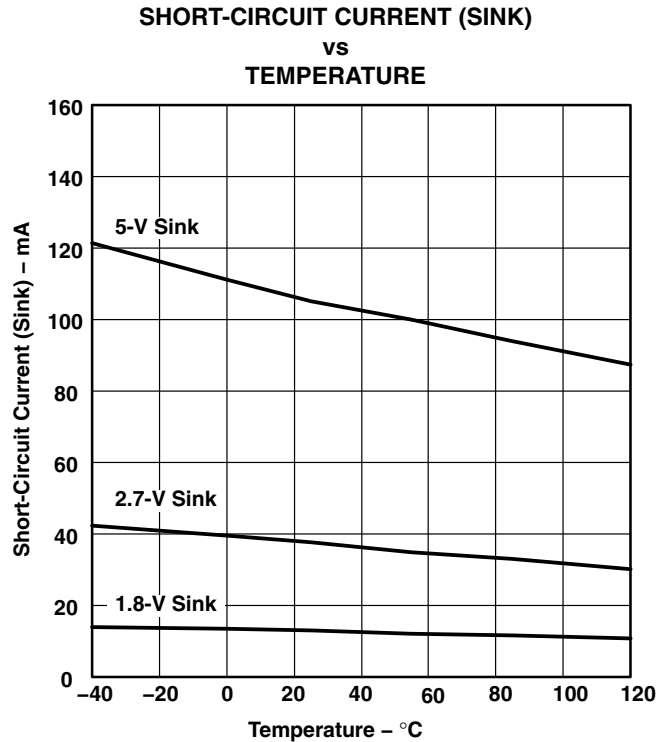


Figure 7

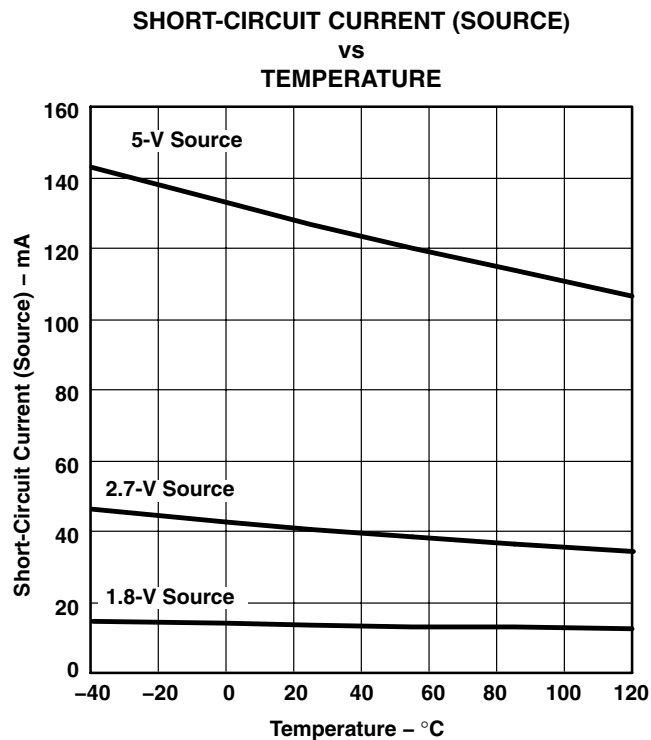


Figure 8

LMV981 SINGLE, LMV982 DUAL

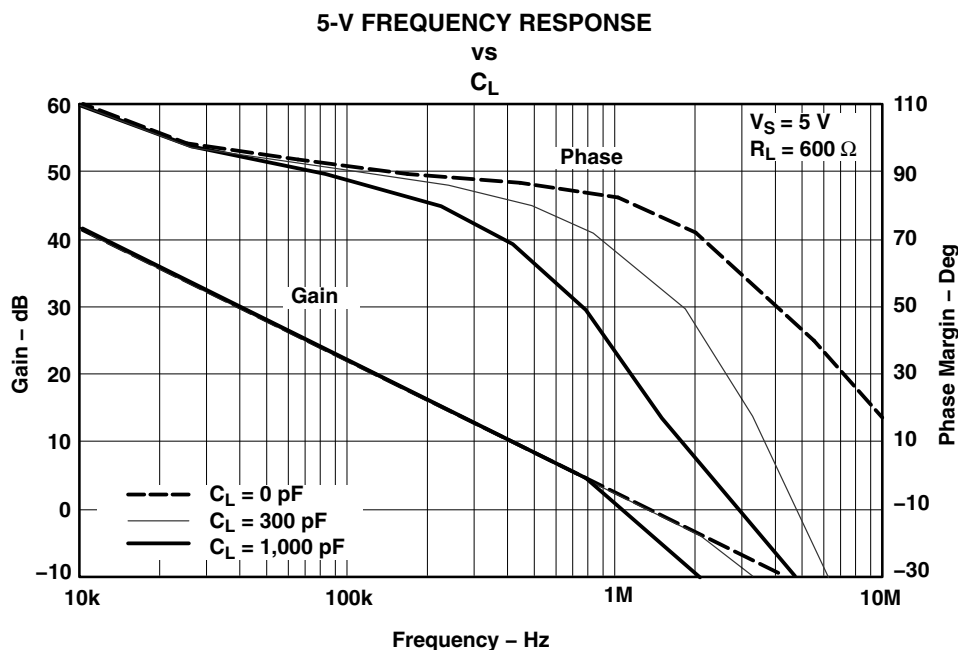
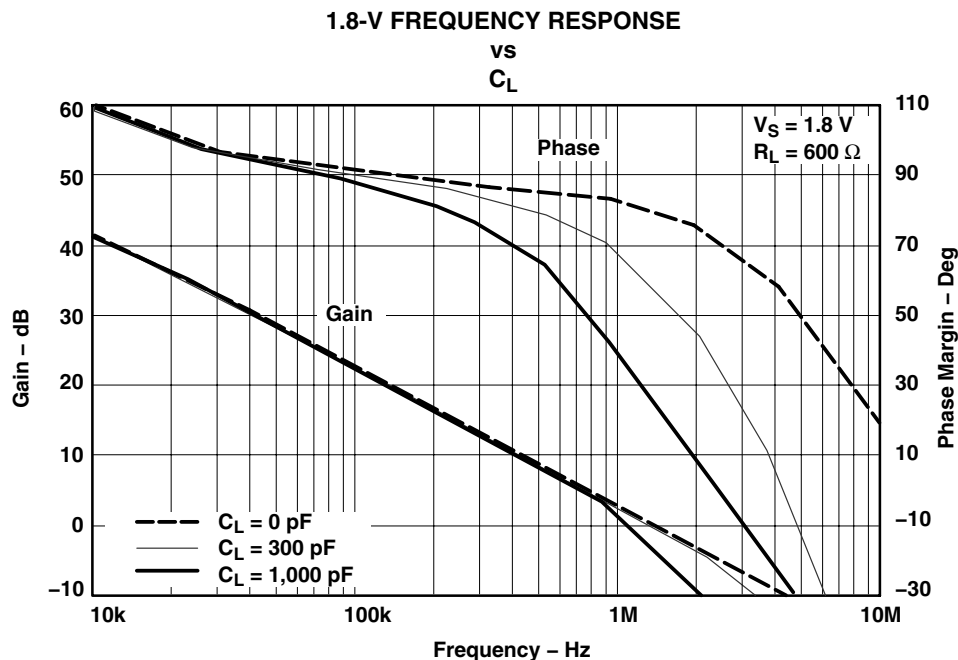
1.8-V OPERATIONAL AMPLIFIERS

WITH RAIL-TO-RAIL INPUT AND OUTPUT AND SHUTDOWN

SLOS440H – AUGUST 2004 – REVISED JULY 2007

TYPICAL PERFORMANCE CHARACTERISTICS

Unless Otherwise Specified, $V_{CC+} = 5\text{ V}$, Single Supply, $T_A = 25^\circ\text{C}$



LMV981 SINGLE, LMV982 DUAL 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT AND SHUTDOWN

SLOS440H – AUGUST 2004 – REVISED JULY 2007

TYPICAL PERFORMANCE CHARACTERISTICS

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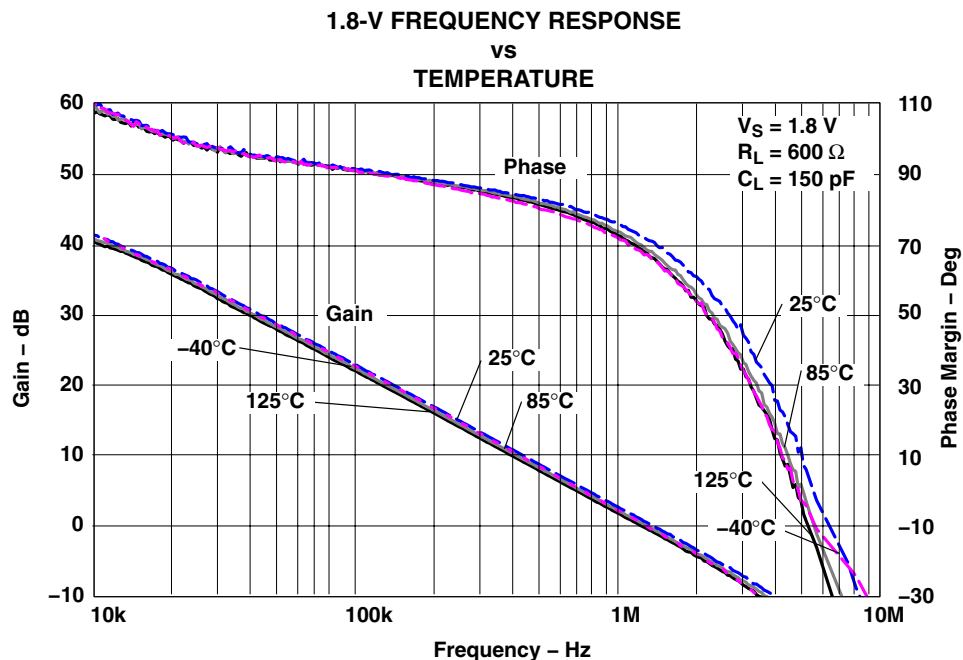


Figure 11

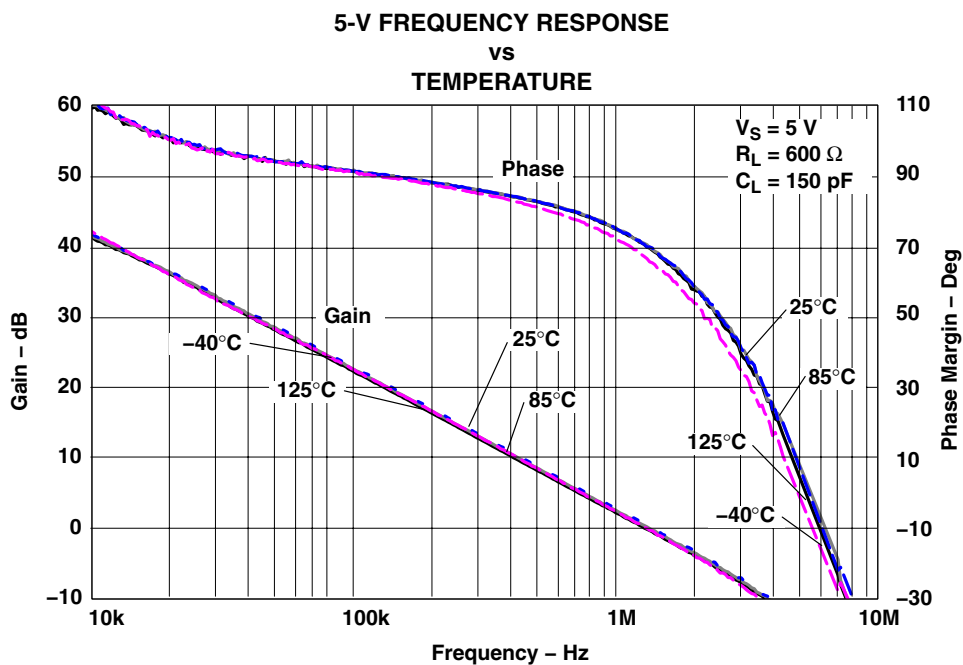


Figure 12

LMV981 SINGLE, LMV982 DUAL 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT AND SHUTDOWN

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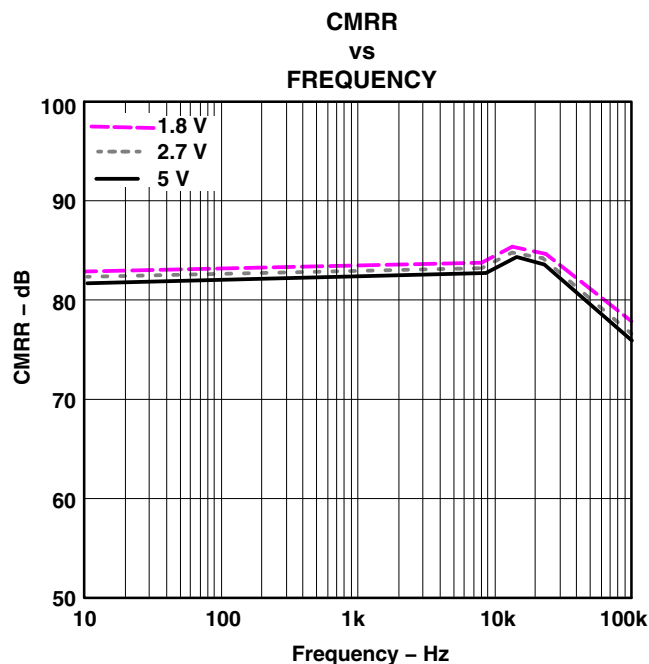


Figure 13

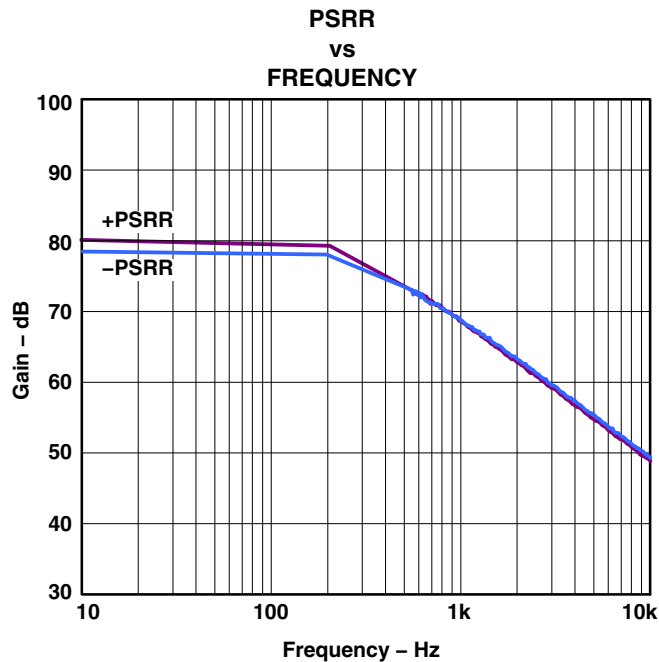


Figure 14

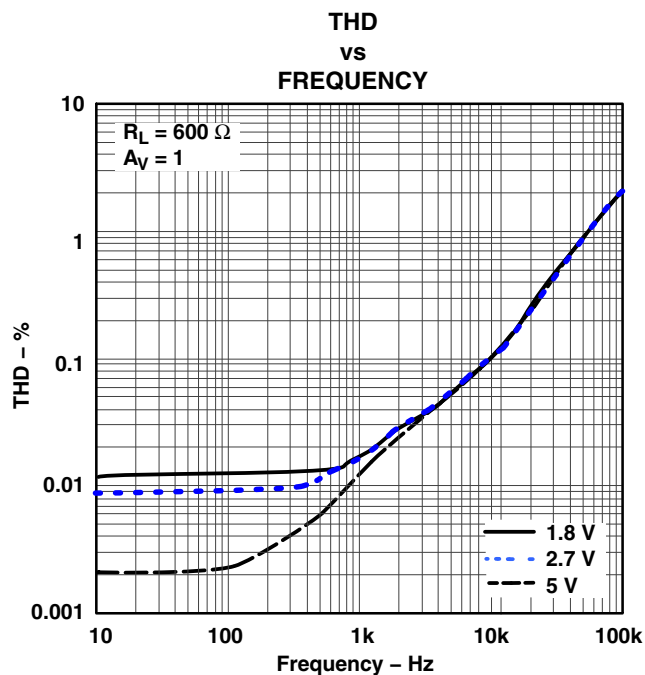


Figure 15

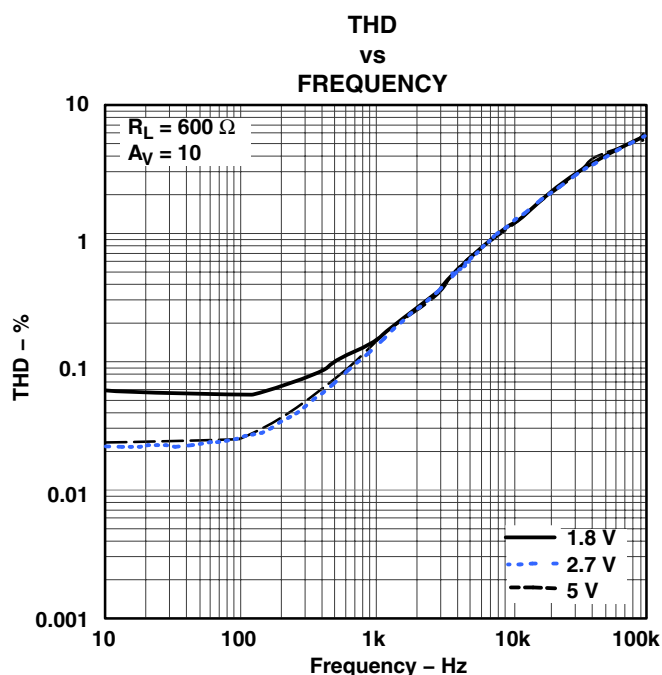


Figure 16

LMV981 SINGLE, LMV982 DUAL 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT AND SHUTDOWN

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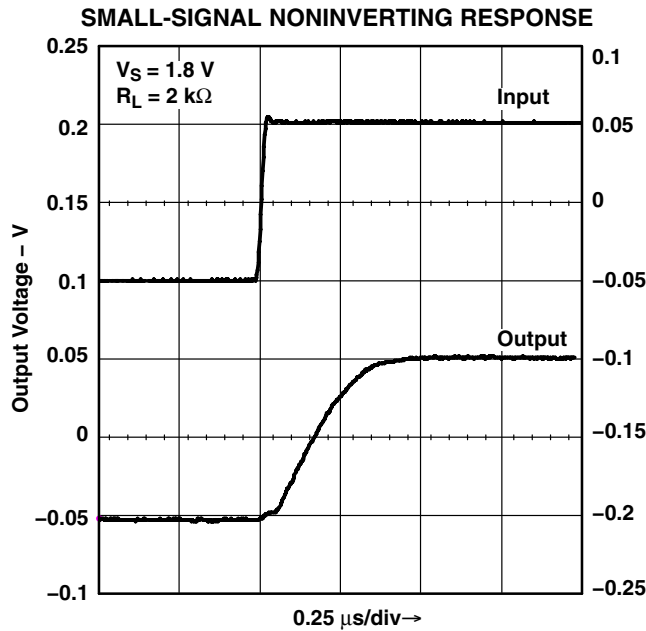


Figure 17

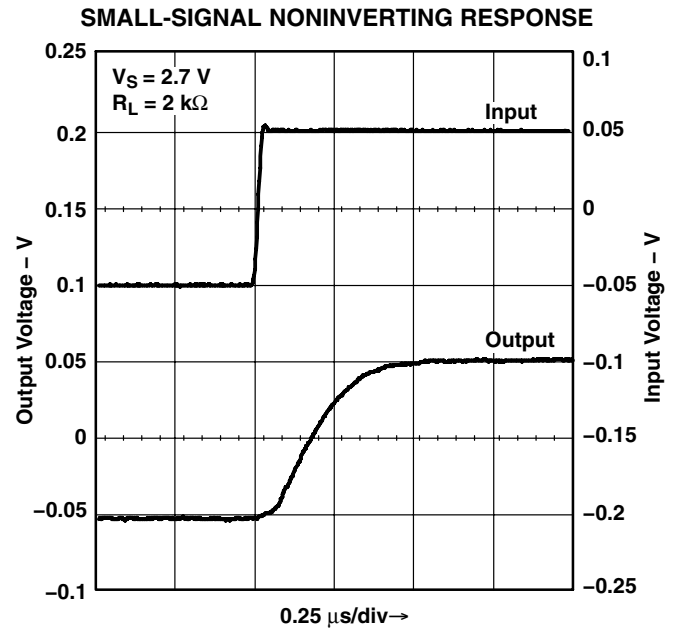


Figure 18

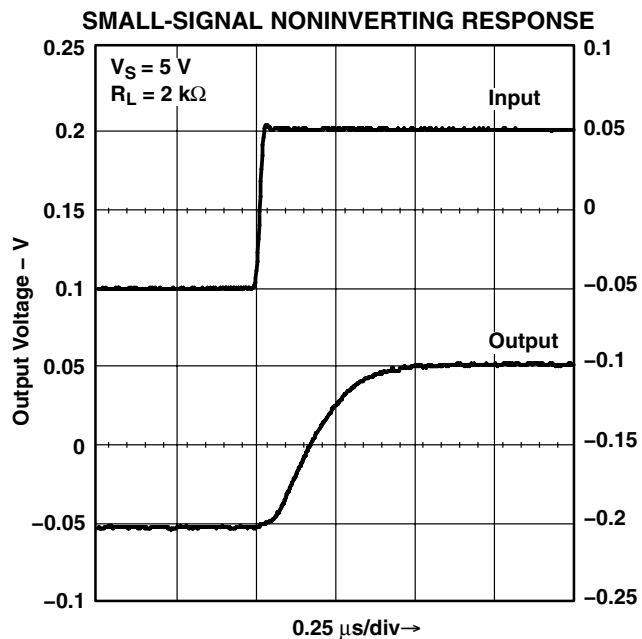


Figure 19

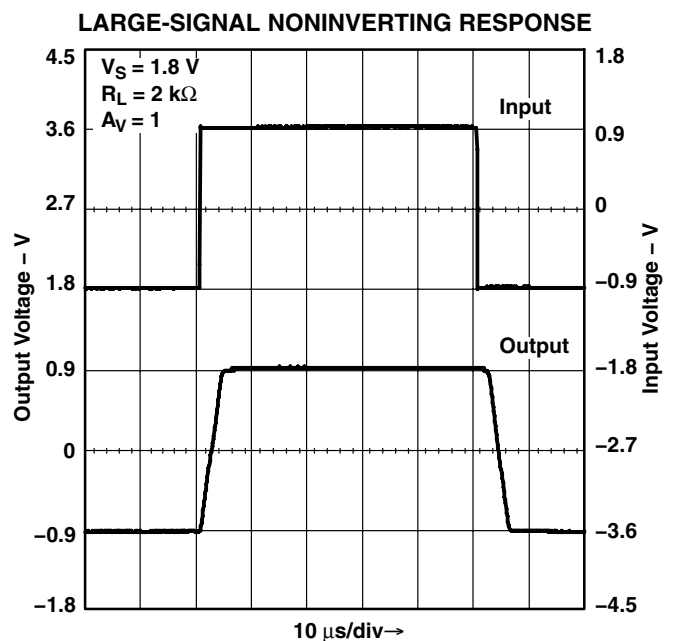


Figure 20

LMV981 SINGLE, LMV982 DUAL 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT AND SHUTDOWN

SLOS440H – AUGUST 2004 – REVISED JULY 2007

TYPICAL PERFORMANCE CHARACTERISTICS

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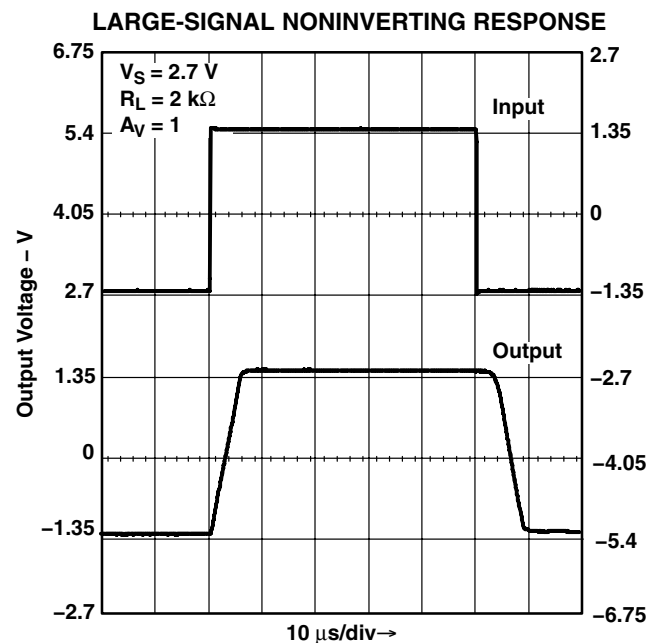


Figure 21

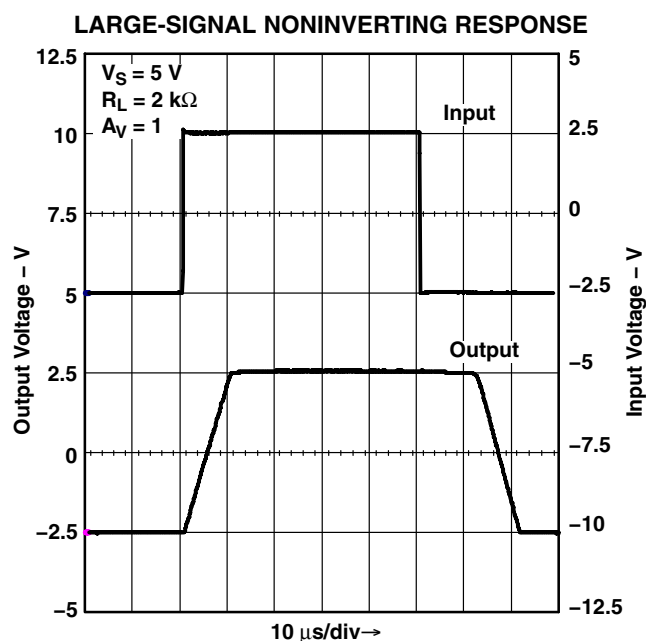


Figure 22

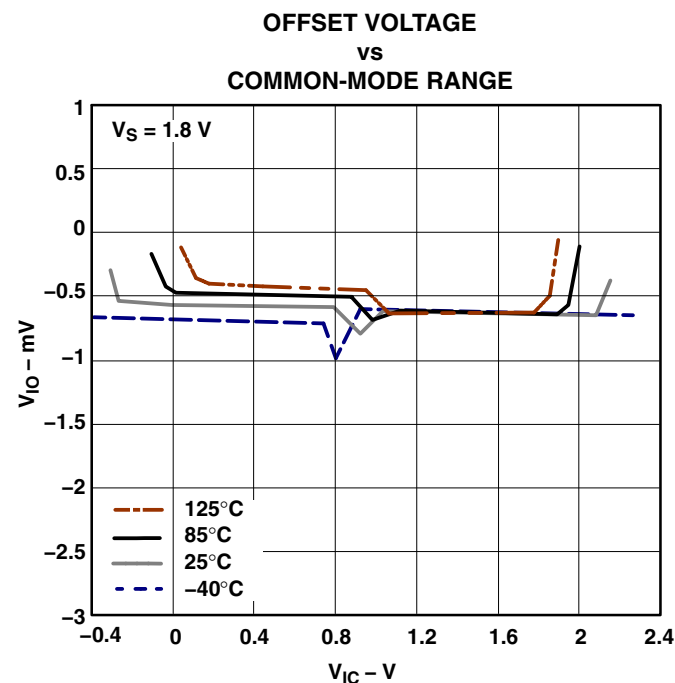


Figure 23

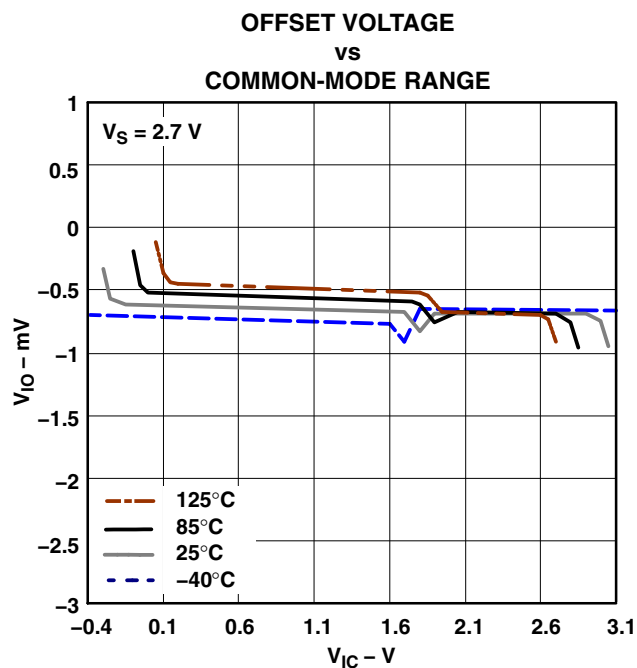


Figure 24

LMV981 SINGLE, LMV982 DUAL 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT AND SHUTDOWN

SLOS440H – AUGUST 2004 – REVISED JULY 2007

TYPICAL PERFORMANCE CHARACTERISTICS

Unless Otherwise Specified, $V_{CC+} = 5\text{ V}$, Single Supply, $T_A = 25^\circ\text{C}$

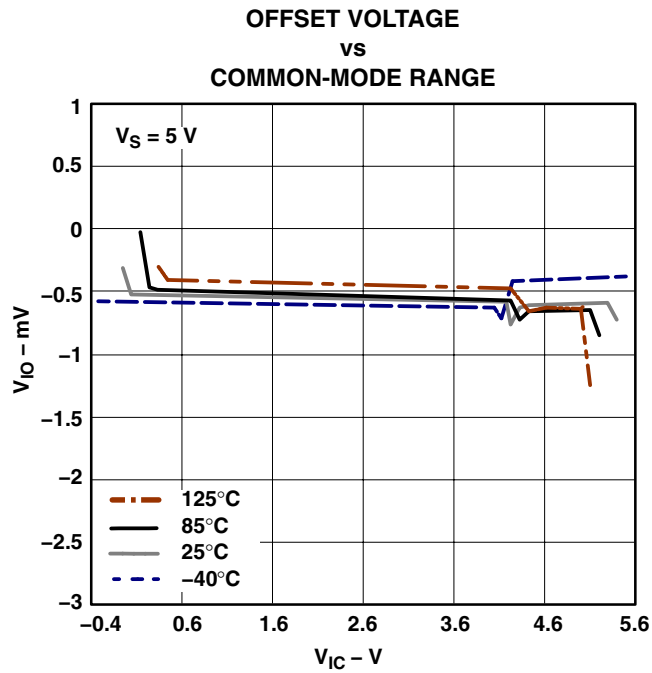


Figure 25

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
LMV981IDBVR	NRND	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
LMV981IDBVRE4	NRND	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
LMV981IDBVRG4	NRND	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
LMV981IDCKR	NRND	SC70	DCK	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
LMV981IDCKRE4	NRND	SC70	DCK	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
LMV981IDCKRG4	NRND	SC70	DCK	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
LMV981IRUGR	NRND	X2QFN	RUG	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
LMV981IRUGRG4	NRND	X2QFN	RUG	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
LMV982IDGSR	NRND	MSOP	DGS	10	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
LMV982IDGSRE4	NRND	MSOP	DGS	10	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
LMV982IDGSRG4	NRND	MSOP	DGS	10	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION
REEL DIMENSIONS

TAPE DIMENSIONS


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMV981IDBVR	SOT-23	DBV	6	3000	180.0	8.4	3.23	3.17	1.37	4.0	8.0	Q3
LMV981IDCKR	SC70	DCK	6	3000	180.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
LMV981IRUGR	X2QFN	RUG	8	3000	179.0	8.4	1.7	1.7	0.6	4.0	8.0	Q2
LMV982IDGSR	MSOP	DGS	10	2500	330.0	12.4	5.3	3.3	1.3	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS

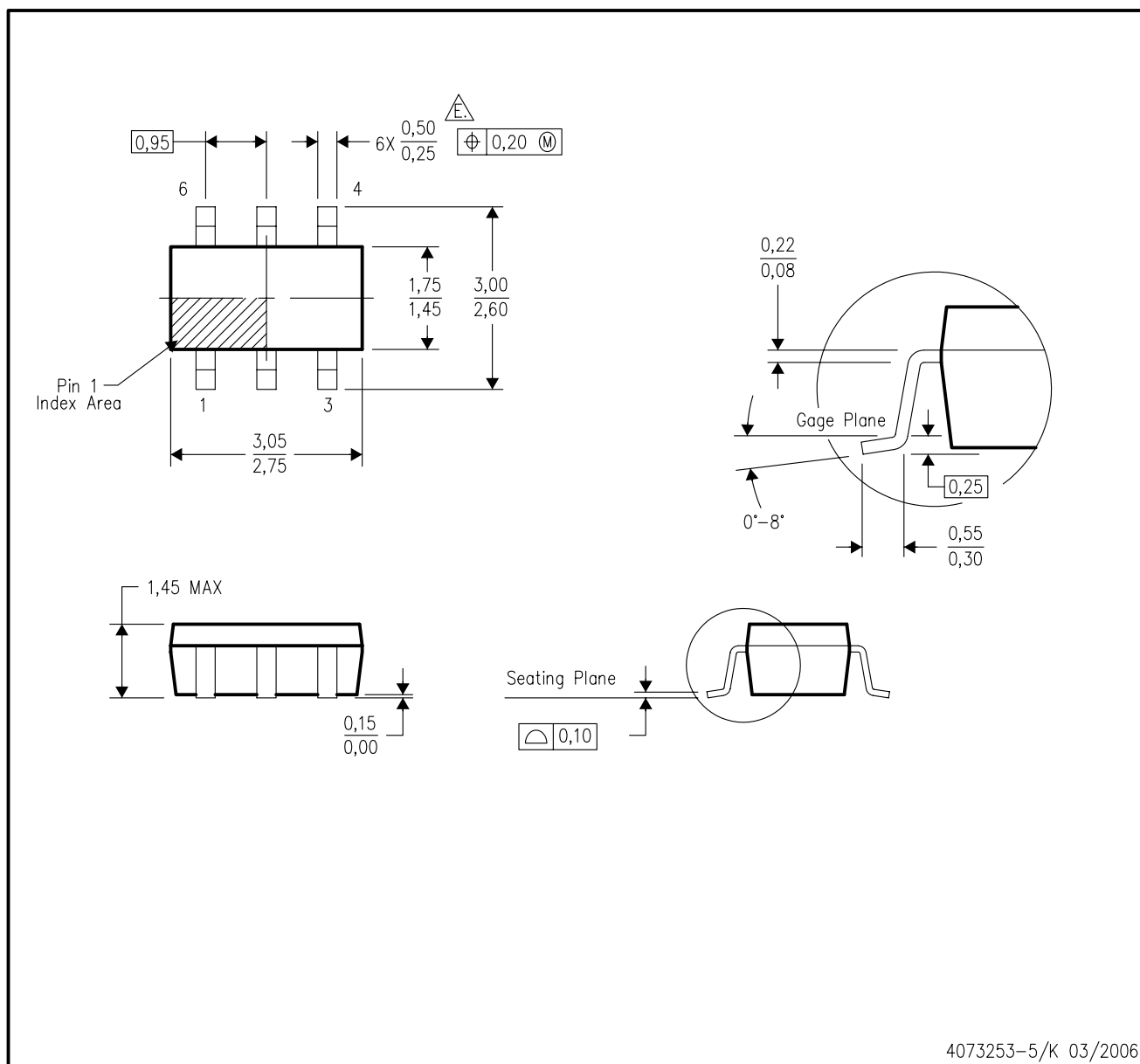


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMV981IDBVR	SOT-23	DBV	6	3000	202.0	201.0	28.0
LMV981IDCKR	SC70	DCK	6	3000	202.0	201.0	28.0
LMV981IRUGR	X2QFN	RUG	8	3000	203.0	203.0	35.0
LMV982IDGSR	MSOP	DGS	10	2500	370.0	355.0	55.0

DBV (R-PDSO-G6)

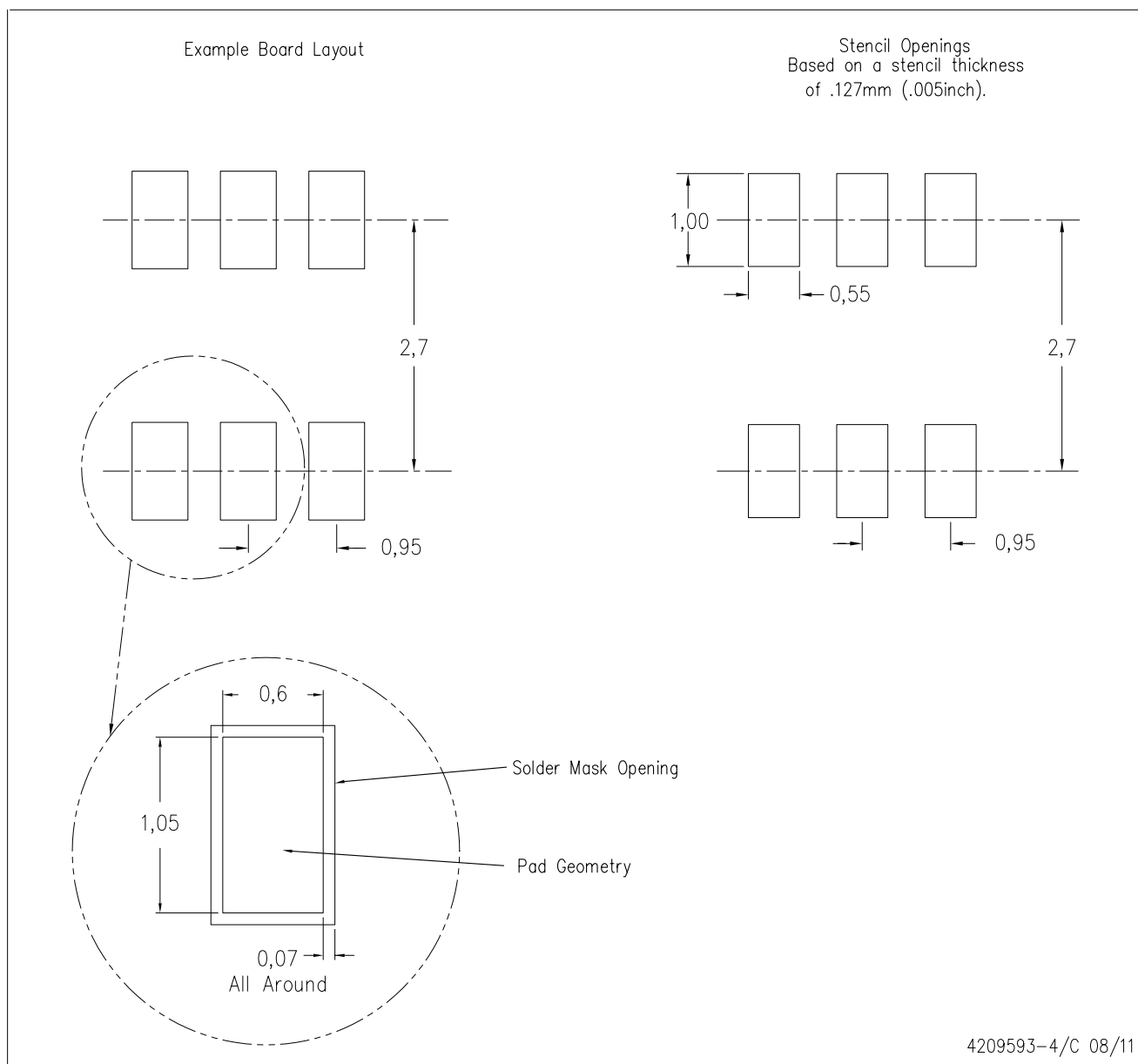
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
- $\triangle$ Falls within JEDEC MO-178 Variation AB, except minimum lead width.

DBV (R-PDSO-G6)

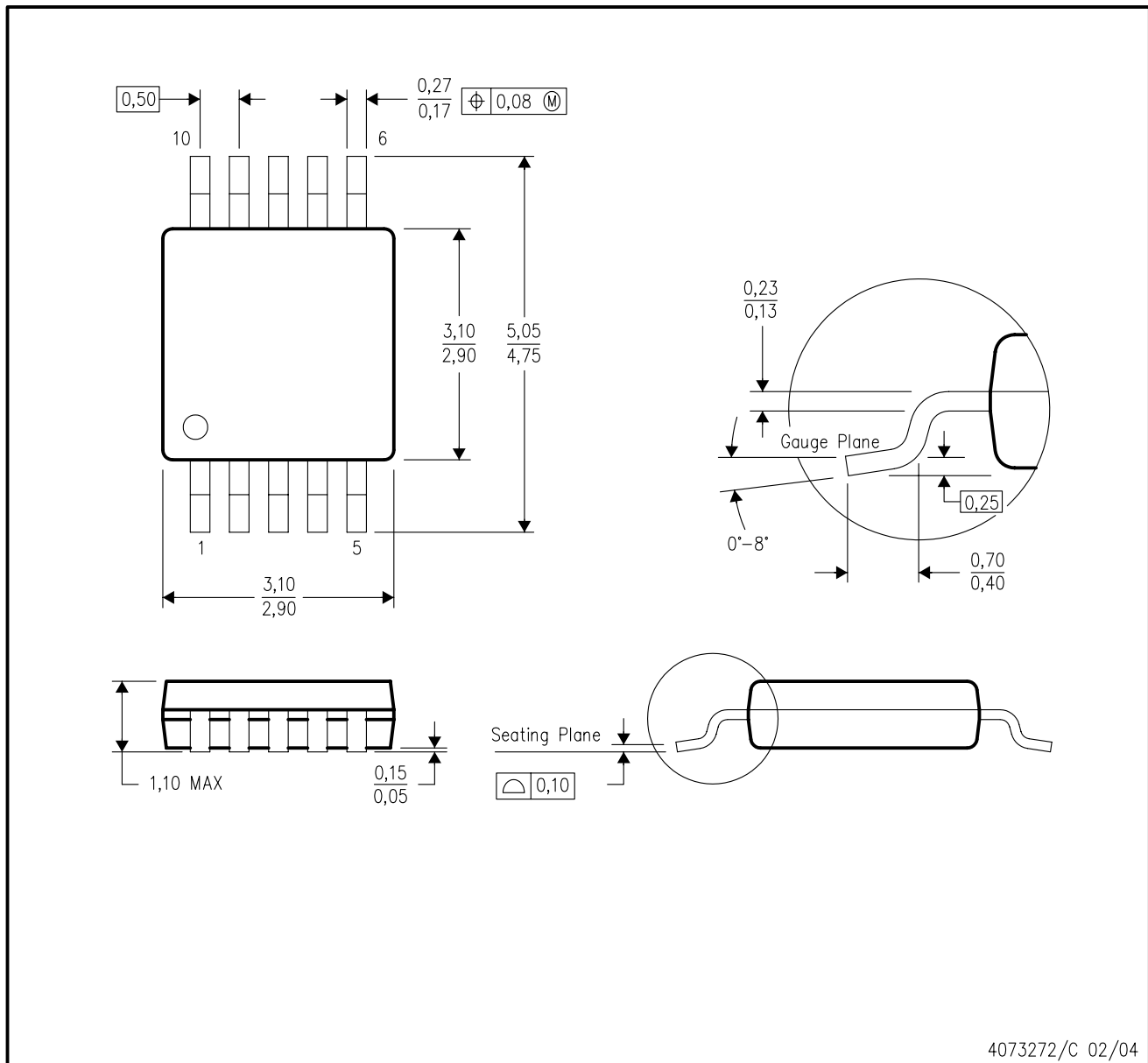
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
 - D. Publication IPC-7351 is recommended for alternate designs.
 - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

DGS (S-PDSO-G10)

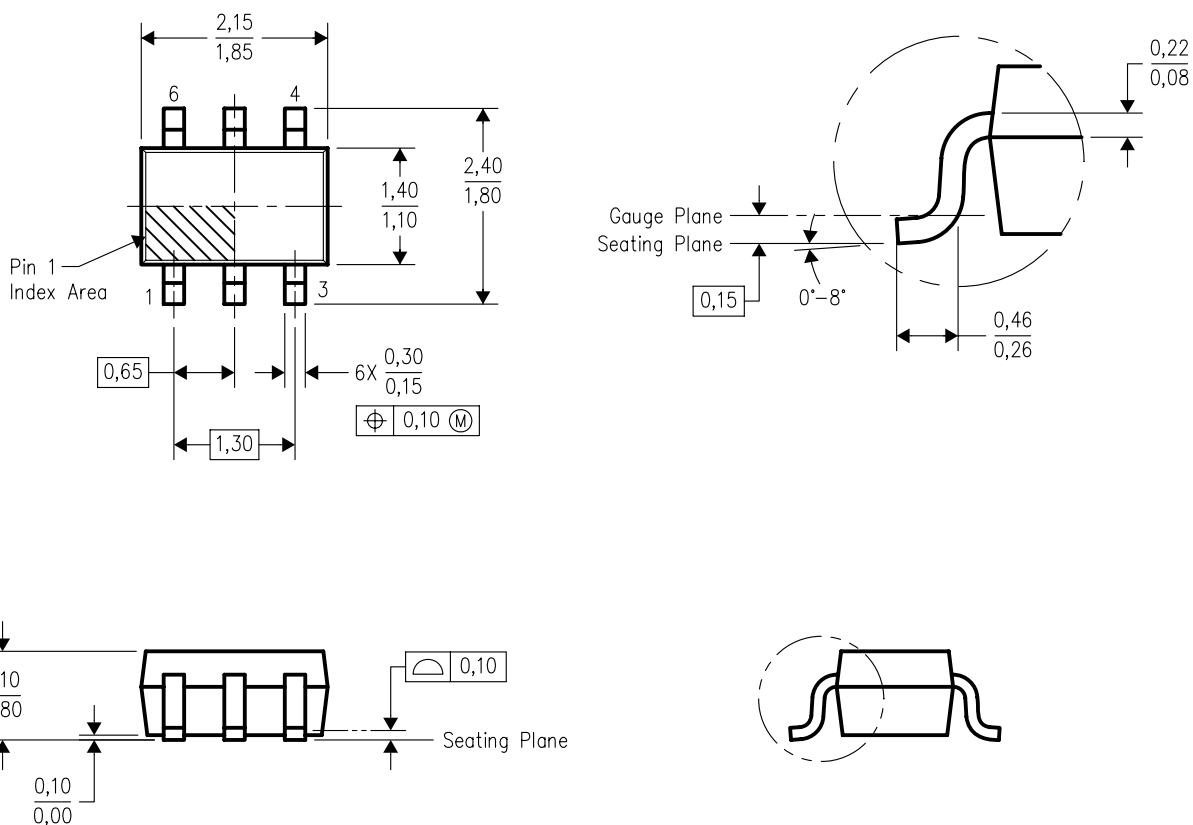
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion.
 - Falls within JEDEC MO-187 variation BA.

DCK (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE

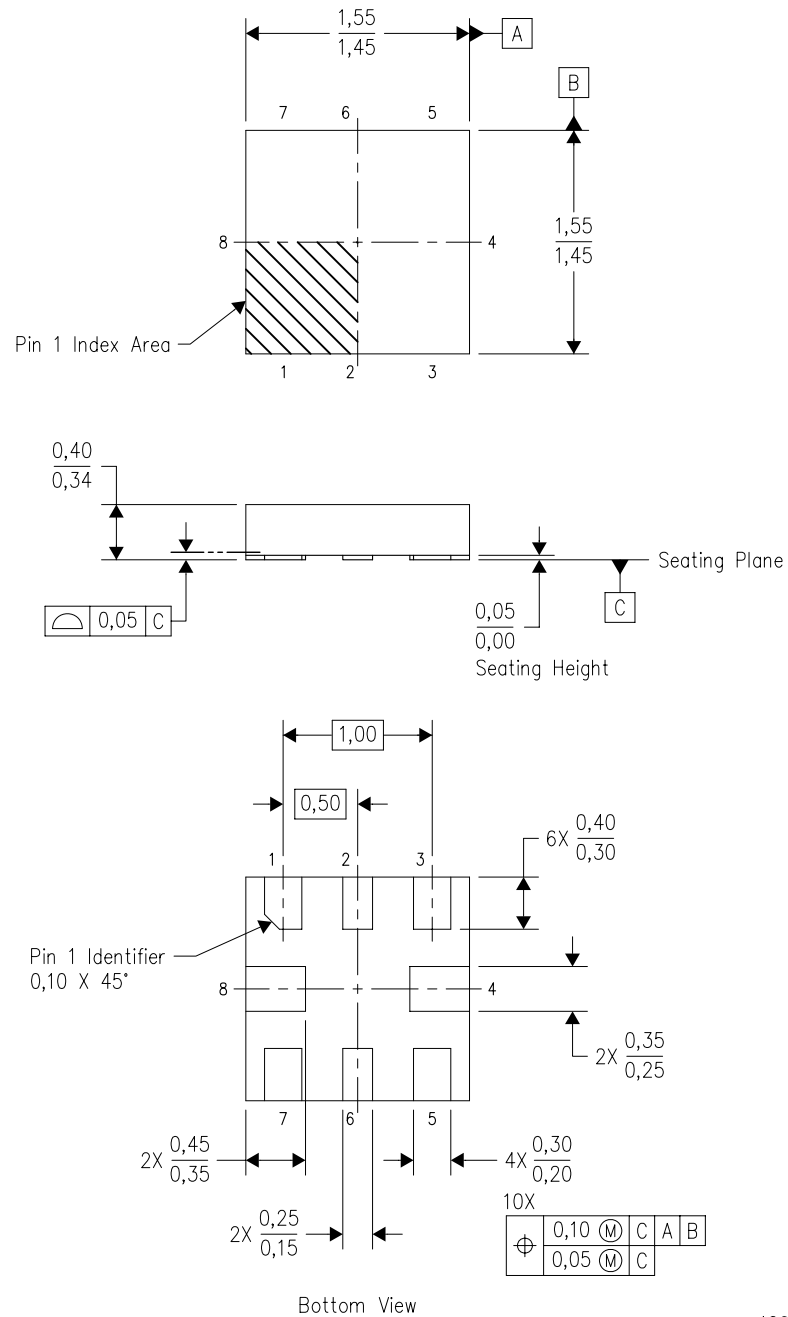


4093553-4/G 01/2007

- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - Falls within JEDEC MO-203 variation AB.

RUG (S-PQFP-N8)

PLASTIC QUAD FLATPACK

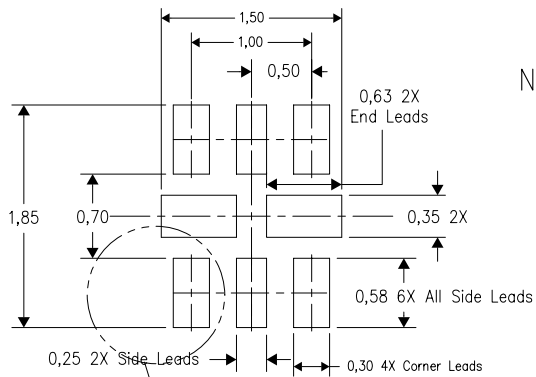


4208528-2/B 04/2008

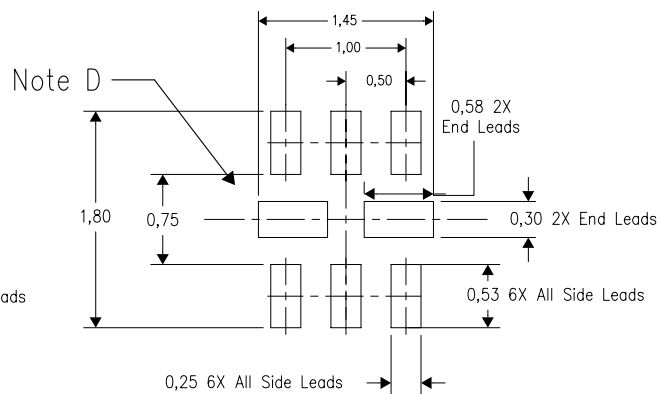
- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - This drawing is subject to change without notice.
 - QFN (Quad Flatpack No-Lead) package configuration.
 - This package complies to JEDEC MO-288 variation X2ECD.

RUG (R-PQFP-N8)

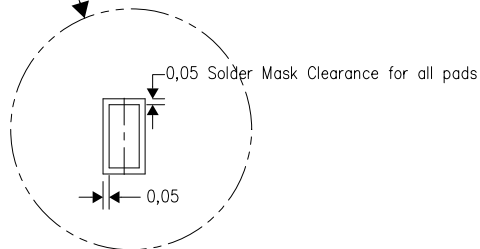
Example Board Layout



Example Stencil Design
(Note E)



Note D



4210299-2/A 06/09

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.
 - E. Maximum stencil thickness 0,127 mm (5 mils). All linear dimensions are in millimeters.
 - F. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
 - G. Side aperture dimensions over-print land for acceptable area ratio > 0.66. Customer may reduce side aperture dimensions if stencil manufacturing process allows for sufficient release at smaller opening.

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